



**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant: Hou, *et al.*      Attorney Docket: TSM03-0151  
Filed: October 22, 2003      Examiner: TBD  
Serial No.: 10/691,019      Art Unit: TBD  
Title: Method of Forming A Contact On A Silicon-On-Insulator Wafer

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**PRELIMINARY AMENDMENT**

Prior to examination on the merits, Applicants respectfully submit this Preliminary Amendment as set forth below: